

# ISL2110, ISL2111

100V, 3A/4A Peak, High Frequency Half-Bridge Drivers

The [ISL2110](#), [ISL2111](#) are 100V, high frequency, half-bridge N-Channel power MOSFET driver ICs. They are based on the popular HIP2100, HIP2101 half-bridge drivers, but offer several performance improvements. Peak output pull-up/pull-down current has been increased to 3A/4A, which significantly reduces switching power losses and eliminates the need for external totem-pole buffers in many applications. Also, the low end of the  $V_{DD}$  operational supply range has been extended to 8VDC. The ISL2110 has additional input hysteresis for superior operation in noisy environments and the inputs of the ISL2111, like those of the ISL2110, can now safely swing to the  $V_{DD}$  supply rail.

## Applications

- Telecom half-bridge DC/DC converters
- Telecom full-bridge DC/DC converters
- Two-switch forward converters
- Active-clamp forward converters
- Class-D audio amplifiers

## Features

- Drives N-Channel MOSFET half-bridge
- SOIC, DFN, and TDFN package options
- SOIC, DFN, and TDFN packages compliant with 100V conductor spacing guidelines per IPC-2221
- Pb-free (RoHS compliant)
- Bootstrap supply max voltage to 114VDC
- On-chip 1W bootstrap diode
- Fast propagation times for multi-MHz circuits
- Drives 1nF load with typical rise/fall times of 9ns/7.5ns
- CMOS compatible input thresholds (ISL2110)
- 3.3V/TTL compatible input thresholds (ISL2111)
- Independent inputs provide flexibility
- No start-up problems
- Outputs unaffected by supply glitches, HS ringing below ground or HS slewing at high dv/dt
- Low power consumption
- Wide supply voltage range (8V to 14V)
- Supply undervoltage protection
- 1.6W/1W typical output pull-up/pull-down resistance

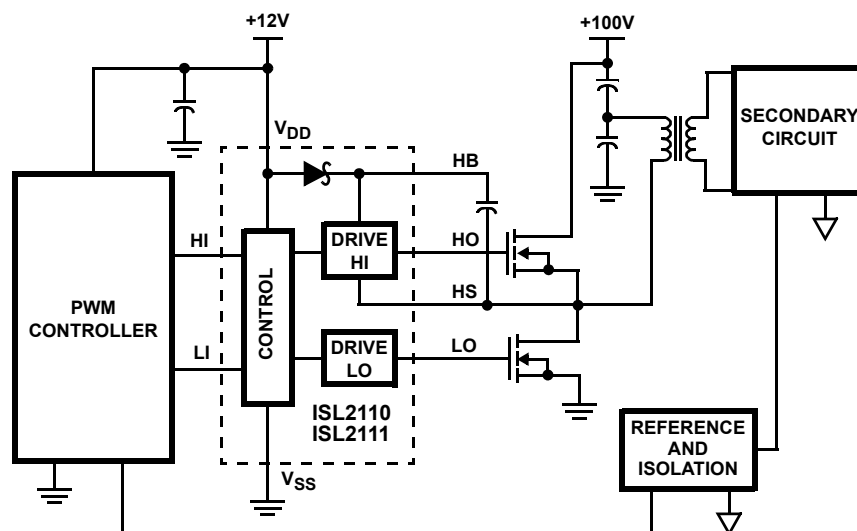
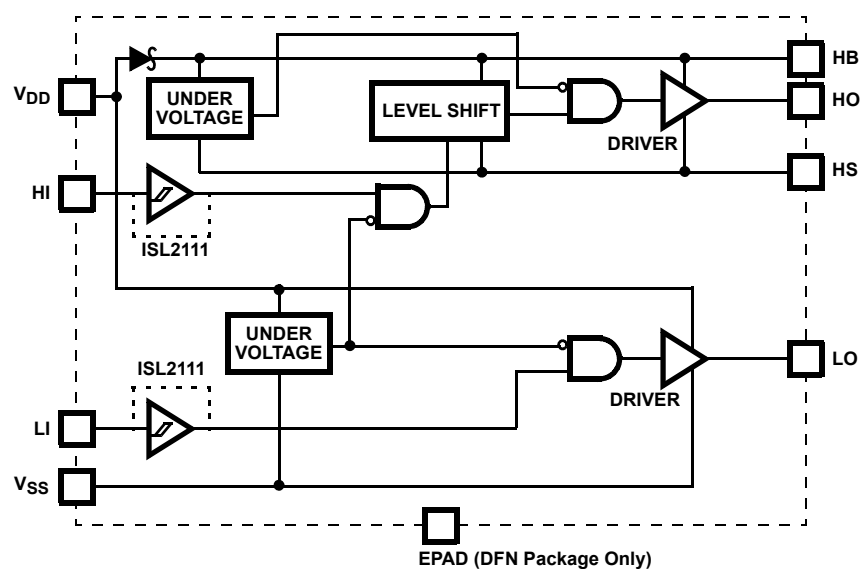


FIGURE 1. APPLICATION BLOCK DIAGRAM

## Functional Block Diagram



\*EPAD = Exposed Pad. The EPAD is electrically isolated from all other pins. For best thermal performance, connect the EPAD to the PCB power ground plane.

FIGURE 2. FUNCTIONAL BLOCK DIAGRAM

## Application Diagrams

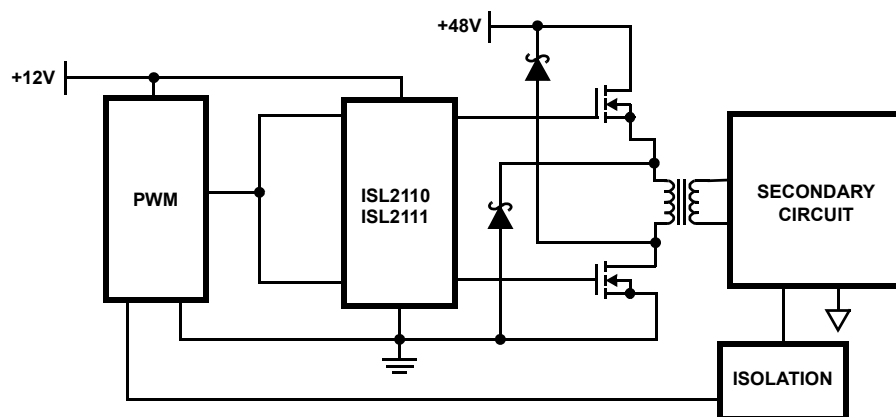


FIGURE 3. TWO-SWITCH FORWARD CONVERTER

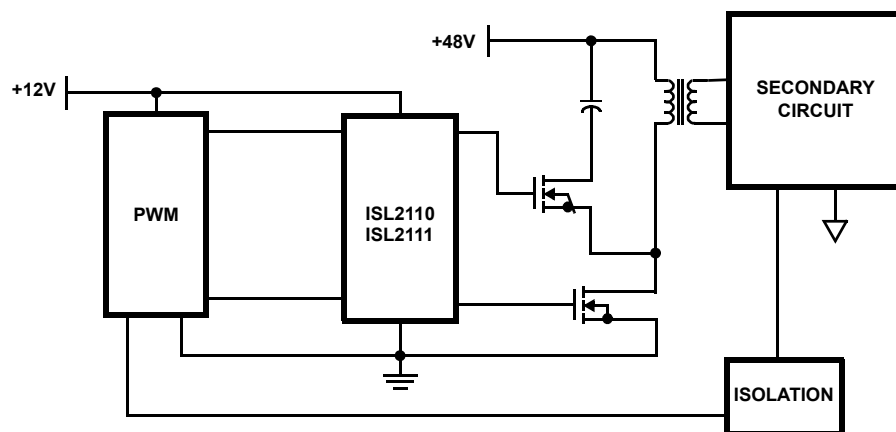


FIGURE 4. FORWARD CONVERTER WITH AN ACTIVE-CLAMP

## Ordering Information

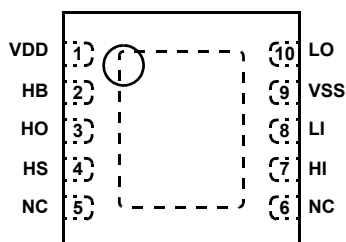
| PART NUMBER<br>(Notes 2, 3) | PART<br>MARKING | PACKAGE DESCRIPTION<br>(RoHS COMPLIANT) | PKG.<br>DWG. # | CARRIER TYPE<br>(Notes 1) | TEMP RANGE    |
|-----------------------------|-----------------|-----------------------------------------|----------------|---------------------------|---------------|
| ISL2110ABZ                  | 2110<br>ABZ     | 8 Ld SOIC                               | M8.15          | Tube                      | -40 to +125°C |
| ISL2110ABZ-T                |                 |                                         |                | Reel, 2.5k                |               |
| ISL2110AR4Z                 | 211<br>0AR4Z    | 12 Ld 4x4 DFN                           | L12.4x4A       | Tube                      |               |
| ISL2110AR4Z-T               |                 |                                         |                | Reel, 6k                  |               |
| ISL2111ABZ                  | 2111<br>ABZ     | 8 Ld SOIC                               | M8.15          | Tube                      |               |
| ISL2111ABZ-T                |                 |                                         |                | Reel, 2.5k                |               |
| ISL2111AR4Z                 | 211<br>1AR4Z    | 12 Ld 4x4 DFN                           | L12.4x4A       | Tube                      |               |
| ISL2111AR4Z-T               |                 |                                         |                | Reel, 6k                  |               |
| ISL2111ARTZ                 | 211<br>1ARTZ    | 10 Ld 4x4 TDFN                          | L10.4x4        | Tube                      |               |
| ISL2111ARTZ-T               |                 |                                         |                | Reel, 6k                  |               |
| ISL2111BR4Z                 | 211<br>1BR4Z    | 8 Ld 4x4 DFN                            | L8.4x4         | Tube                      |               |
| ISL2111BR4Z-T               |                 |                                         |                | Reel, 6k                  |               |

### NOTES:

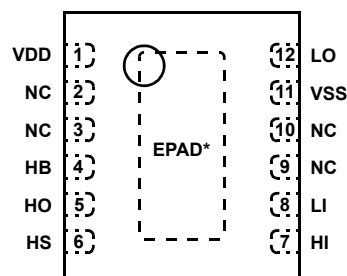
- See [TB347](#) for details about reel specifications.
- These Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
- For Moisture Sensitivity Level (MSL), please see device information page for [ISL2110](#), [ISL2111](#). For more information on MSL, see [TB363](#).

## Pin Configurations

ISL2111ARTZ  
(10 LD 4x4 TDFN)  
TOP VIEW

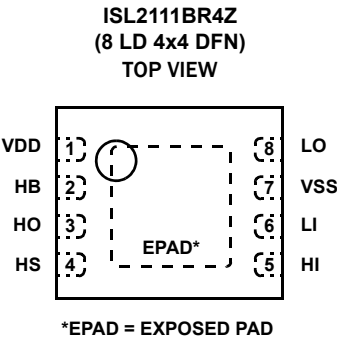
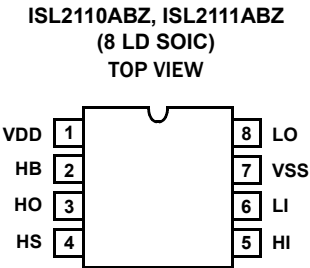


ISL2110AR4Z, ISL2111AR4Z  
(12 LD 4x4 DFN)  
TOP VIEW



\*EPAD = EXPOSED PAD

## Pin Configurations



## Pin Descriptions

| SYMBOL | DESCRIPTION                                                                                                                                                 |
|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|
| VDD    | Positive supply to lower gate driver. Bypass this pin to VSS.                                                                                               |
| HB     | High-side bootstrap supply. External bootstrap capacitor is required. Connect positive side of bootstrap capacitor to this pin. Bootstrap diode is on-chip. |
| HO     | High-side output. Connect to gate of high-side power MOSFET.                                                                                                |
| HS     | High-side source connection. Connect to source of high-side power MOSFET. Connect negative side of bootstrap capacitor to this pin.                         |
| HI     | High-side input                                                                                                                                             |
| LI     | Low-side input                                                                                                                                              |
| VSS    | Chip negative supply, which will generally be ground.                                                                                                       |
| LO     | Low-side output. Connect to gate of low-side power MOSFET.                                                                                                  |
| NC     | No connect                                                                                                                                                  |
| EPAD   | Exposed pad. Connect to ground or float. The EPAD is electrically isolated from all other pins.                                                             |

## Absolute Maximum Ratings

|                                                              |                                    |
|--------------------------------------------------------------|------------------------------------|
| Supply Voltage, $V_{DD}$ , $V_{HB}$ - $V_{HS}$ (Notes 4, 5)  | 0.3V to 18V                        |
| LI and HI Voltages (Note 5)                                  | -0.3V to $V_{DD} + 0.3V$           |
| Voltage on LO (Note 5)                                       | -0.3V to $V_{DD} + 0.3V$           |
| Voltage on HO relative to HS (Repetitive Transient < 100ns)  | -2V                                |
| Voltage on LO relative to GND (Repetitive Transient < 100ns) | -2V                                |
| Voltage on HO (Note 5)                                       | $V_{HS} - 0.3V$ to $V_{HB} + 0.3V$ |
| Voltage on HS (Continuous) (Note 5)                          | -1V to 110V                        |
| Voltage on HB (Note 5)                                       | 118V                               |
| Average Current in $V_{DD}$ to HB Diode                      | 100mA                              |

## Maximum Recommended Operating Conditions

|                                              |                                                                      |
|----------------------------------------------|----------------------------------------------------------------------|
| Supply Voltage, $V_{DD}$                     | 8V to 14V                                                            |
| Voltage on HS                                | -1V to 100V                                                          |
| Voltage on HS (Repetitive Transient < 100ns) | -5V to 105V                                                          |
| Voltage on HB                                | $V_{HS} + 7V$ to $V_{HS} + 14V$ and $V_{DD} - 1V$ to $V_{DD} + 100V$ |
| HS Slew Rate                                 | <50V/ns                                                              |

**CAUTION:** Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

### NOTES:

- The ISL2110 and ISL2111 are capable of derated operation at supply voltages exceeding 14V. Figure 24 shows the high-side voltage derating curve for this mode of operation.
- All voltages referenced to  $V_{SS}$  unless otherwise specified.
- $\theta_{JA}$  is measured with the component mounted on a high-effective thermal conductivity test board in free air. See Tech Brief TB379 for details.
- $\theta_{JA}$  is measured in free air with the component mounted on a high-effective thermal conductivity test board with "direct attach" features. See Tech Brief TB379.
- For  $\theta_{JC}$ , the "case temp" location is the center of the exposed metal pad on the package underside.
- For  $\theta_{JC}$ , the "case temp" location is taken at the package top center.

## Thermal Information

| Thermal Resistance (Typical)               | $\theta_{JA}$ (°C/W) | $\theta_{JC}$ (°C/W) |
|--------------------------------------------|----------------------|----------------------|
| 8 Ld SOIC (Notes 6, 9)                     | 95                   | 46                   |
| 10 Ld TDFN (Notes 7, 8)                    | 40                   | 2.5                  |
| 12 Ld DFN (Notes 7, 8)                     | 39                   | 2.5                  |
| 8 Ld DFN (Notes 7, 8)                      | 40                   | 4.0                  |
| Max Power Dissipation at +25°C in Free Air |                      |                      |
| 8 Ld SOIC (Notes 6, 9)                     |                      | 1.3W                 |
| 10 Ld TDFN (Notes 7, 8)                    |                      | 3.0W                 |
| 12 Ld DFN (Notes 7, 8)                     |                      | 3.1W                 |
| 8 Ld DFN (Notes 7, 8)                      |                      | 3.1W                 |
| Storage Temperature Range                  |                      | -65°C to +150°C      |
| Junction Temperature Range                 |                      | -55°C to +150°C      |
| Pb-Free Reflow Profile                     |                      | see TB493            |

## Electrical Specifications $V_{DD} = V_{HB} = 12V$ , $V_{SS} = V_{HS} = 0V$ , no load on LO or HO, unless otherwise specified.

| PARAMETERS                               | SYMBOL            | TEST CONDITIONS                                        | T <sub>J</sub> = +25°C |      |                  | T <sub>J</sub> = -40°C to +125°C |                  | UNIT |
|------------------------------------------|-------------------|--------------------------------------------------------|------------------------|------|------------------|----------------------------------|------------------|------|
|                                          |                   |                                                        | MIN<br>(Note 10)       | TYP  | MAX<br>(Note 10) | MIN<br>(Note 10)                 | MAX<br>(Note 10) |      |
| SUPPLY CURRENTS                          |                   |                                                        |                        |      |                  |                                  |                  |      |
| V <sub>DD</sub> Quiescent Current        | I <sub>DD</sub>   | ISL2110; LI = HI = 0V                                  | -                      | 0.10 | 0.25             | -                                | 0.30             | mA   |
| V <sub>DD</sub> Quiescent Current        | I <sub>DD</sub>   | ISL2111; LI = HI = 0V                                  | -                      | 0.30 | 0.45             | -                                | 0.55             | mA   |
| V <sub>DD</sub> Operating Current        | I <sub>DDO</sub>  | ISL2110; f = 500kHz                                    | -                      | 3.4  | 5.0              | -                                | 5.5              | mA   |
| V <sub>DD</sub> Operating Current        | I <sub>DDO</sub>  | ISL2111; f = 500kHz                                    | -                      | 3.5  | 5.0              | -                                | 5.5              | mA   |
| Total HB Quiescent Current               | I <sub>HB</sub>   | LI = HI = 0V                                           | -                      | 0.10 | 0.15             | -                                | 0.20             | mA   |
| Total HB Operating Current               | I <sub>HBO</sub>  | f = 500kHz                                             | -                      | 3.4  | 5.0              | -                                | 5.5              | mA   |
| HB to V <sub>SS</sub> Current, Quiescent | I <sub>HBS</sub>  | LI = HI = 0V; V <sub>HB</sub> = V <sub>HS</sub> = 114V | -                      | 0.05 | 1.50             | -                                | 10               | μA   |
| HB to V <sub>SS</sub> Current, Operating | I <sub>HBSO</sub> | f = 500kHz; V <sub>HB</sub> = V <sub>HS</sub> = 114V   | -                      | 1.2  | -                | -                                | -                | mA   |
| INPUT PINS                               |                   |                                                        |                        |      |                  |                                  |                  |      |
| Low Level Input Voltage Threshold        | V <sub>IL</sub>   | ISL2110                                                | 3.7                    | 4.4  | -                | 3.5                              | -                | V    |
| Low Level Input Voltage Threshold        | V <sub>IL</sub>   | ISL2111                                                | 1.4                    | 1.8  | -                | 1.2                              | -                | V    |
| High Level Input Voltage Threshold       | V <sub>IH</sub>   | ISL2110                                                | -                      | 6.6  | 7.4              | -                                | 7.6              | V    |
| High Level Input Voltage Threshold       | V <sub>IH</sub>   | ISL2111                                                | -                      | 1.8  | 2.2              | -                                | 2.4              | V    |
| Input Voltage Hysteresis                 | V <sub>IHYS</sub> | ISL2110                                                | -                      | 2.2  | -                | -                                | -                | V    |

**Electrical Specifications**  $V_{DD} = V_{HB} = 12V$ ,  $V_{SS} = V_{HS} = 0V$ , no load on LO or HO, unless otherwise specified. (Continued)

| PARAMETERS                     | SYMBOL    | TEST CONDITIONS                                 | $T_J = +25^\circ C$ |      |                  | $T_J = -40^\circ C \text{ to } +125^\circ C$ |                  | UNIT       |
|--------------------------------|-----------|-------------------------------------------------|---------------------|------|------------------|----------------------------------------------|------------------|------------|
|                                |           |                                                 | MIN<br>(Note 10)    | TYP  | MAX<br>(Note 10) | MIN<br>(Note 10)                             | MAX<br>(Note 10) |            |
| Input Pull-Down Resistance     | $R_I$     |                                                 | -                   | 210  | -                | 100                                          | 500              | k $\Omega$ |
| <b>UNDERVOLTAGE PROTECTION</b> |           |                                                 |                     |      |                  |                                              |                  |            |
| $V_{DD}$ Rising Threshold      | $V_{DDR}$ |                                                 | 6.1                 | 6.6  | 7.1              | 5.8                                          | 7.4              | V          |
| $V_{DD}$ Threshold Hysteresis  | $V_{DDH}$ |                                                 | -                   | 0.6  | -                | -                                            | -                | V          |
| HB Rising Threshold            | $V_{HBR}$ |                                                 | 5.5                 | 6.1  | 6.8              | 5.0                                          | 7.1              | V          |
| HB Threshold Hysteresis        | $V_{HBH}$ |                                                 | -                   | 0.6  | -                | -                                            | -                | V          |
| <b>BOOTSTRAP DIODE</b>         |           |                                                 |                     |      |                  |                                              |                  |            |
| Low Current Forward Voltage    | $V_{DL}$  | $I_{VDD-HB} = 100\mu A$                         | -                   | 0.5  | 0.6              | -                                            | 0.7              | V          |
| High Current Forward Voltage   | $V_{DH}$  | $I_{VDD-HB} = 100mA$                            | -                   | 0.7  | 0.9              | -                                            | 1                | V          |
| Dynamic Resistance             | $R_D$     | $I_{VDD-HB} = 100mA$                            | -                   | 0.7  | 1                | -                                            | 1.5              | $\Omega$   |
| <b>LO GATE DRIVER</b>          |           |                                                 |                     |      |                  |                                              |                  |            |
| Low Level Output Voltage       | $V_{OLL}$ | $I_{LO} = 100mA$                                | -                   | 0.1  | 0.18             | -                                            | 0.25             | V          |
| High Level Output Voltage      | $V_{OHL}$ | $I_{LO} = -100mA$ , $V_{OHL} = V_{DD} - V_{LO}$ | -                   | 0.16 | 0.23             | -                                            | 0.3              | V          |
| Peak Pull-Up Current           | $I_{OHL}$ | $V_{LO} = 0V$                                   | -                   | 3    | -                | -                                            | -                | A          |
| Peak Pull-Down Current         | $I_{OLL}$ | $V_{LO} = 12V$                                  | -                   | 4    | -                | -                                            | -                | A          |
| <b>HO GATE DRIVER</b>          |           |                                                 |                     |      |                  |                                              |                  |            |
| Low Level Output Voltage       | $V_{OLH}$ | $I_{HO} = 100mA$                                | -                   | 0.1  | 0.18             | -                                            | 0.25             | V          |
| High Level Output Voltage      | $V_{OHH}$ | $I_{HO} = -100mA$ , $V_{OHH} = V_{HB} - V_{HO}$ | -                   | 0.16 | 0.23             | -                                            | 0.3              | V          |
| Peak Pull-Up Current           | $I_{OHH}$ | $V_{HO} = 0V$                                   | -                   | 3    | -                | -                                            | -                | A          |
| Peak Pull-Down Current         | $I_{OLH}$ | $V_{HO} = 12V$                                  | -                   | 4    | -                | -                                            | -                | A          |

**Switching Specifications**  $V_{DD} = V_{HB} = 12V$ ,  $V_{SS} = V_{HS} = 0V$ , No Load on LO or HO, unless otherwise specified.

| PARAMETERS                                                  | SYMBOL     | TEST CONDITIONS  | $T_J = +25^\circ C$ |      |                  | $T_J = -40^\circ C \text{ to } +125^\circ C$ |                  | UNIT    |
|-------------------------------------------------------------|------------|------------------|---------------------|------|------------------|----------------------------------------------|------------------|---------|
|                                                             |            |                  | MIN<br>(Note 10)    | TYP  | MAX<br>(Note 10) | MIN<br>(Note 10)                             | MAX<br>(Note 10) |         |
| Lower Turn-Off Propagation Delay (LI Falling to LO Falling) | $t_{LPHL}$ |                  | -                   | 32   | 50               | -                                            | 60               | ns      |
| Upper Turn-Off Propagation Delay (HI Falling to HO Falling) | $t_{HPHL}$ |                  | -                   | 32   | 50               | -                                            | 60               | ns      |
| Lower Turn-On Propagation Delay (LI Rising to LO Rising)    | $t_{LPLH}$ |                  | -                   | 39   | 50               | -                                            | 60               | ns      |
| Upper Turn-On Propagation Delay (HI Rising to HO Rising)    | $t_{HPLH}$ |                  | -                   | 38   | 50               | -                                            | 60               | ns      |
| Delay Matching: Upper Turn-Off to Lower Turn-On             | $t_{MON}$  |                  | 1                   | 8    | -                | -                                            | 16               | ns      |
| Delay Matching: Lower Turn-Off to Upper Turn-On             | $t_{MOFF}$ |                  | 1                   | 6    | -                | -                                            | 16               | ns      |
| Either Output Rise Time (10% to 90%)                        | $t_{RC}$   | $C_L = 1nF$      | -                   | 9    | -                | -                                            | -                | ns      |
| Either Output Fall Time (90% to 10%)                        | $t_{FC}$   | $C_L = 1nF$      | -                   | 7.5  | -                | -                                            | -                | ns      |
| Either Output Rise Time (3V to 9V)                          | $t_R$      | $C_L = 0.1\mu F$ | -                   | 0.3  | 0.4              | -                                            | 0.5              | $\mu s$ |
| Either Output Fall Time (9V to 3V)                          | $t_F$      | $C_L = 0.1\mu F$ | -                   | 0.19 | 0.3              | -                                            | 0.4              | $\mu s$ |
| Minimum Input Pulse Width that Changes the Output           | $t_{PW}$   |                  | -                   | -    | -                | -                                            | 50               | ns      |
| Bootstrap Diode Turn-On or Turn-Off Time                    | $t_{BS}$   |                  | -                   | 10   | -                | -                                            | -                | ns      |

NOTE:

10. Parameters with MIN and/or MAX limits are 100% tested at  $+25^\circ C$ , unless otherwise specified. Temperature limits established by characterization and are not production tested.

# Timing Diagrams

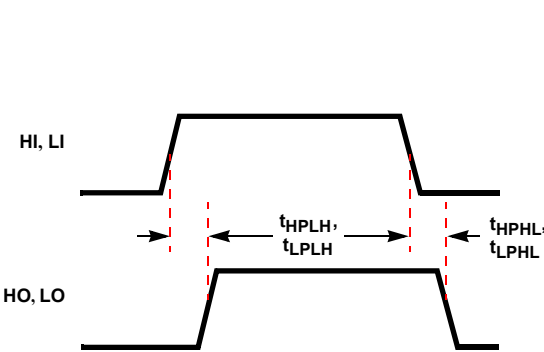


FIGURE 5. PROPAGATION DELAYS

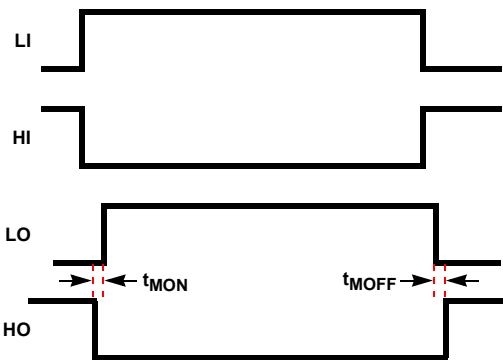


FIGURE 6. DELAY MATCHING

## Typical Performance Curves

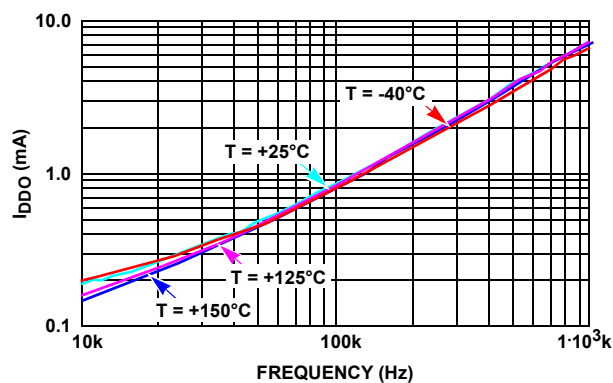
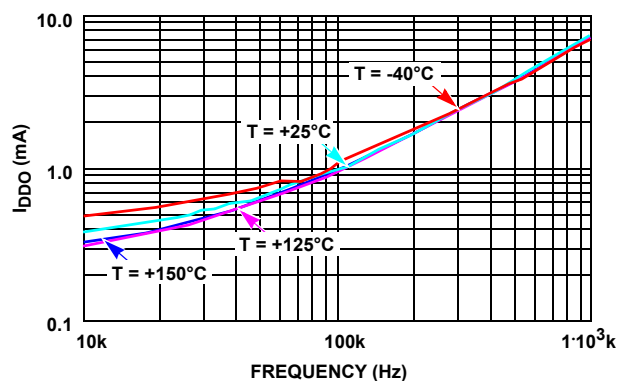
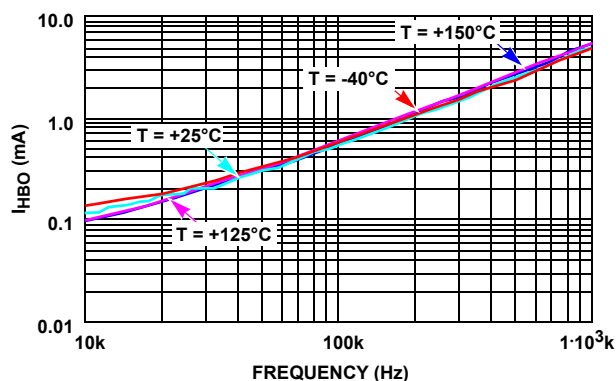
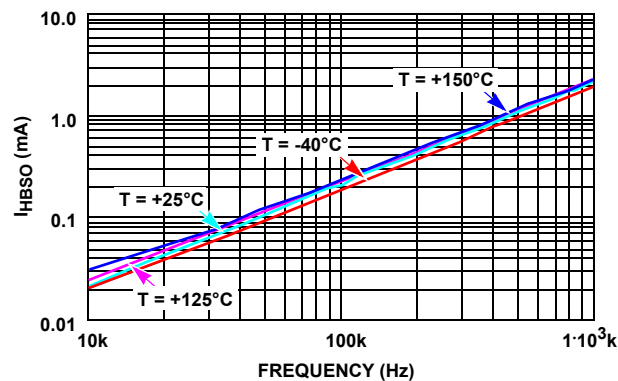
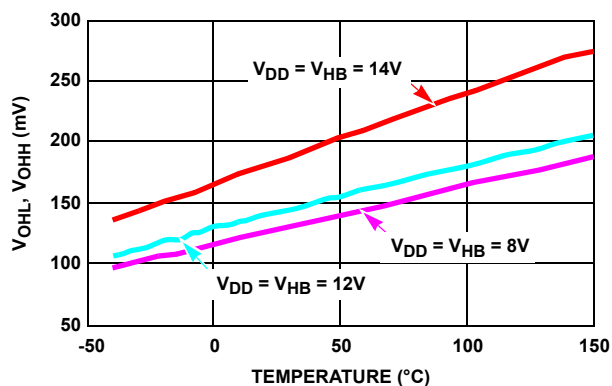
FIGURE 7. ISL2110  $I_{DD}$  OPERATING CURRENT vs FREQUENCYFIGURE 8. ISL2111  $I_{DD}$  OPERATING CURRENT vs FREQUENCYFIGURE 9.  $I_{HB}$  OPERATING CURRENT vs FREQUENCYFIGURE 10.  $I_{HBS}$  OPERATING CURRENT vs FREQUENCY

FIGURE 11. HIGH LEVEL OUTPUT VOLTAGE vs TEMPERATURE

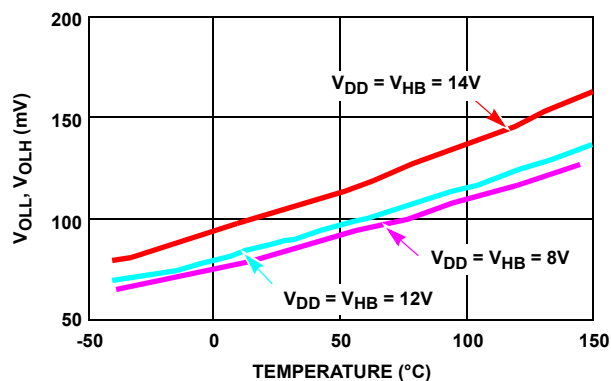


FIGURE 12. LOW LEVEL OUTPUT VOLTAGE vs TEMPERATURE

## Typical Performance Curves (Continued)

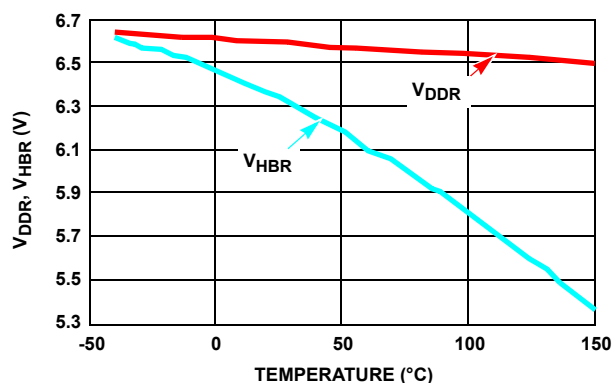


FIGURE 13. UNDERVOLTAGE LOCKOUT THRESHOLD vs TEMPERATURE

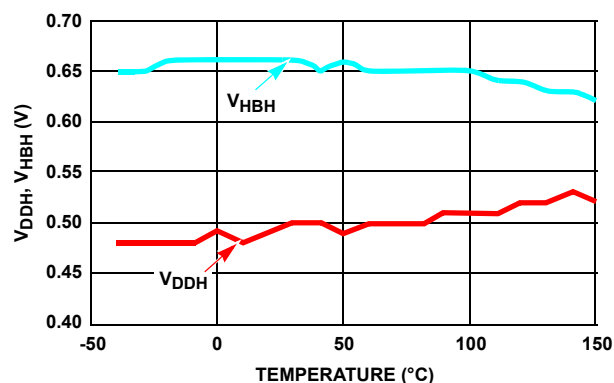


FIGURE 14. UNDERVOLTAGE LOCKOUT HYSTERESIS vs TEMPERATURE

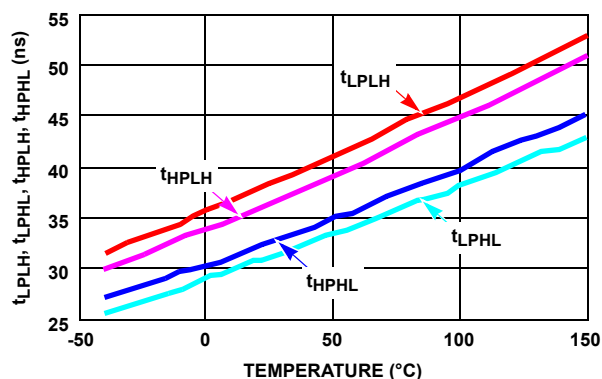


FIGURE 15. ISL2110 PROPAGATION DELAYS vs TEMPERATURE

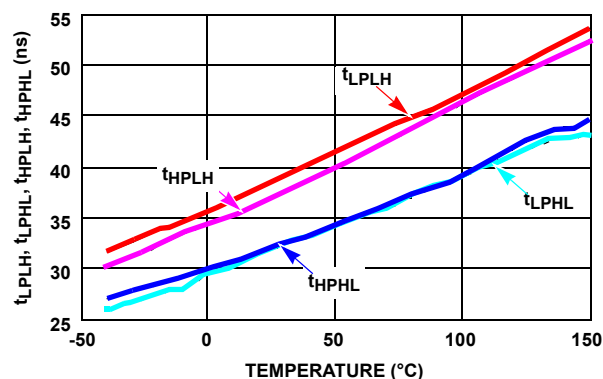


FIGURE 16. ISL2111 PROPAGATION DELAYS vs TEMPERATURE

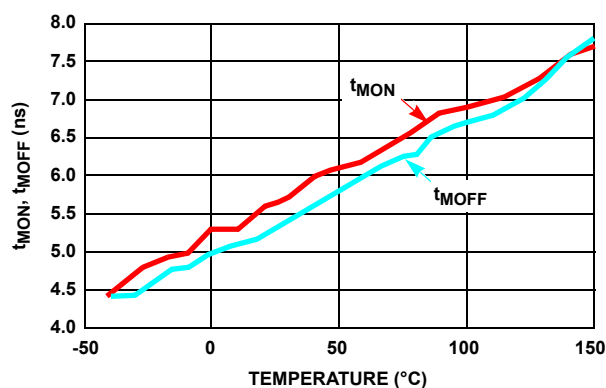


FIGURE 17. ISL2110 DELAY MATCHING vs TEMPERATURE

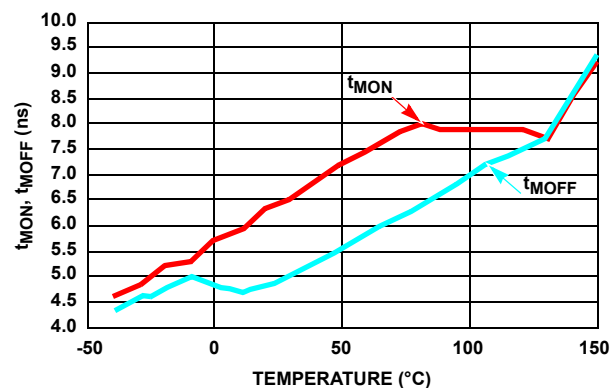


FIGURE 18. ISL2111 DELAY MATCHING vs TEMPERATURE

## Typical Performance Curves (Continued)

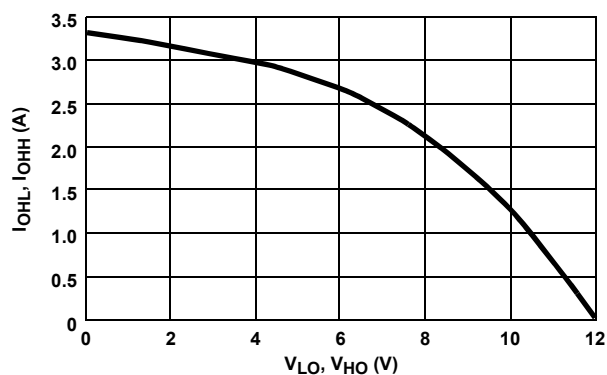


FIGURE 19. PEAK PULL-UP CURRENT vs OUTPUT VOLTAGE

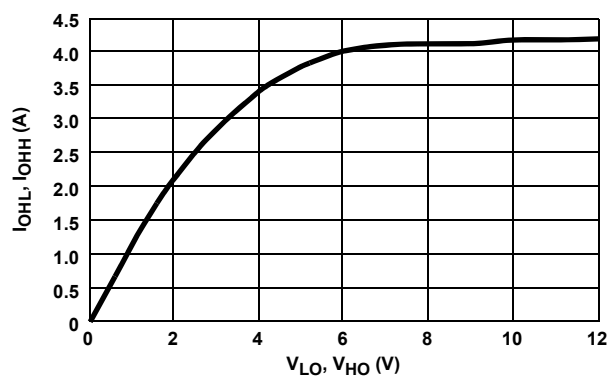


FIGURE 20. PEAK PULL-DOWN CURRENT vs OUTPUT VOLTAGE

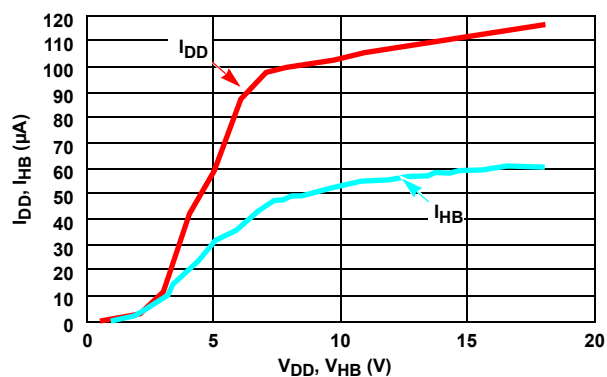


FIGURE 21. ISL2110 QUIESCENT CURRENT vs VOLTAGE

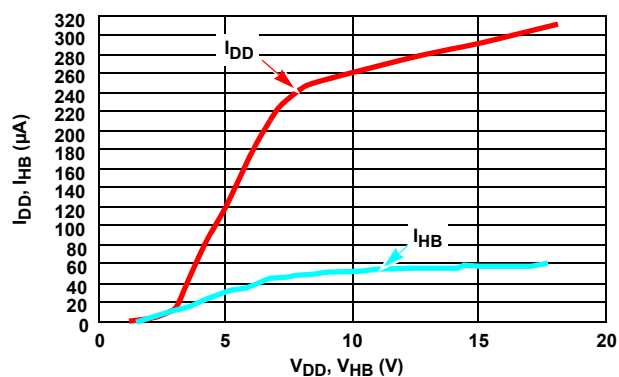


FIGURE 22. ISL2111 QUIESCENT CURRENT vs VOLTAGE

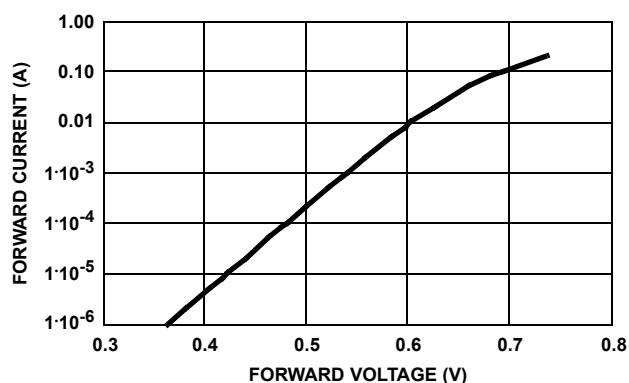
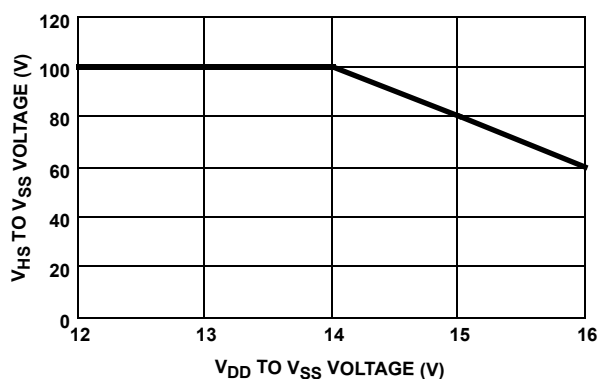


FIGURE 23. BOOTSTRAP DIODE I-V CHARACTERISTICS

FIGURE 24.  $V_{HS}$  VOLTAGE vs  $V_{DD}$  VOLTAGE

## Revision History

The revision history provided is for informational purposes only and is believed to be accurate, but not warranted. Please visit our website to make sure you have the latest revision.

| DATE           | REVISION | CHANGE                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|----------------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Oct 2, 2023    | 8.01     | Updated M8.15 POD to the latest revision (corrected typo).                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| April 18, 2022 | 8.0      | Updated the Ordering information table to comply with the new standard, updated notes.<br>In Absolute Maximum Ratings, added Voltage on HO relative to HS and Voltage on LO relative to GND.<br>Updated POD M8.15 to the latest version: "Added the coplanarity spec into the drawing."<br>Removed Related Literature and About Intersil sections.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| Mar 16, 2017   | 7.0      | <p>Corrected the branding of FG ISL2111BR4Z in the order information table from "211 1BR4A" to "211 1BR4Z".<br/>Added Revision History table and About Intersil information.</p> <p>Updated L10.4x4 Package Outline Drawing from Rev 1 to Rev 2. Change since Rev 1 is:<br/>"Tiebar note update from 'Tiebar shown (if present) is a non-functional feature' to 'Tiebar shown (if present) is a non-functional feature and may be located on any of the 4 sides (or ends)'".</p> <p>Updated L12.4x4A Package Outline Drawing from Rev 1 to Rev 3. Changes since Rev 1 are:<br/>"Tiebar note update from 'Tiebar shown (if present) is a non-functional feature' to 'Tiebar shown (if present) is a non-functional feature and may be located on any of the 4 sides (or ends)'";<br/>"Bottom View changed from '3.2 REF' TO '2.5 REF'";<br/>"Typical Recommended Land Pattern changed from '3.80' to '3.75'";<br/>"Updated to new POD format by removing table listing dimensions and moving dimensions onto drawing",<br/>and "Added typical recommended land pattern".</p> <p>Updated M8.15 Package Outline Drawing from Rev 3 to Rev 4. Change since Rev 3 is:<br/>"Changed Note 1 from 1982 to 1994".</p> <p>Updated L8.4x4 Package Outline Drawing from Rev 0 to Rev 1. Change since Rev 0 is:<br/>"Tiebar note update from 'Tiebar shown (if present) is a non-functional feature' to 'Tiebar shown (if present) is a non-functional feature and may be located on any of the 4 sides (or ends)'".</p> |

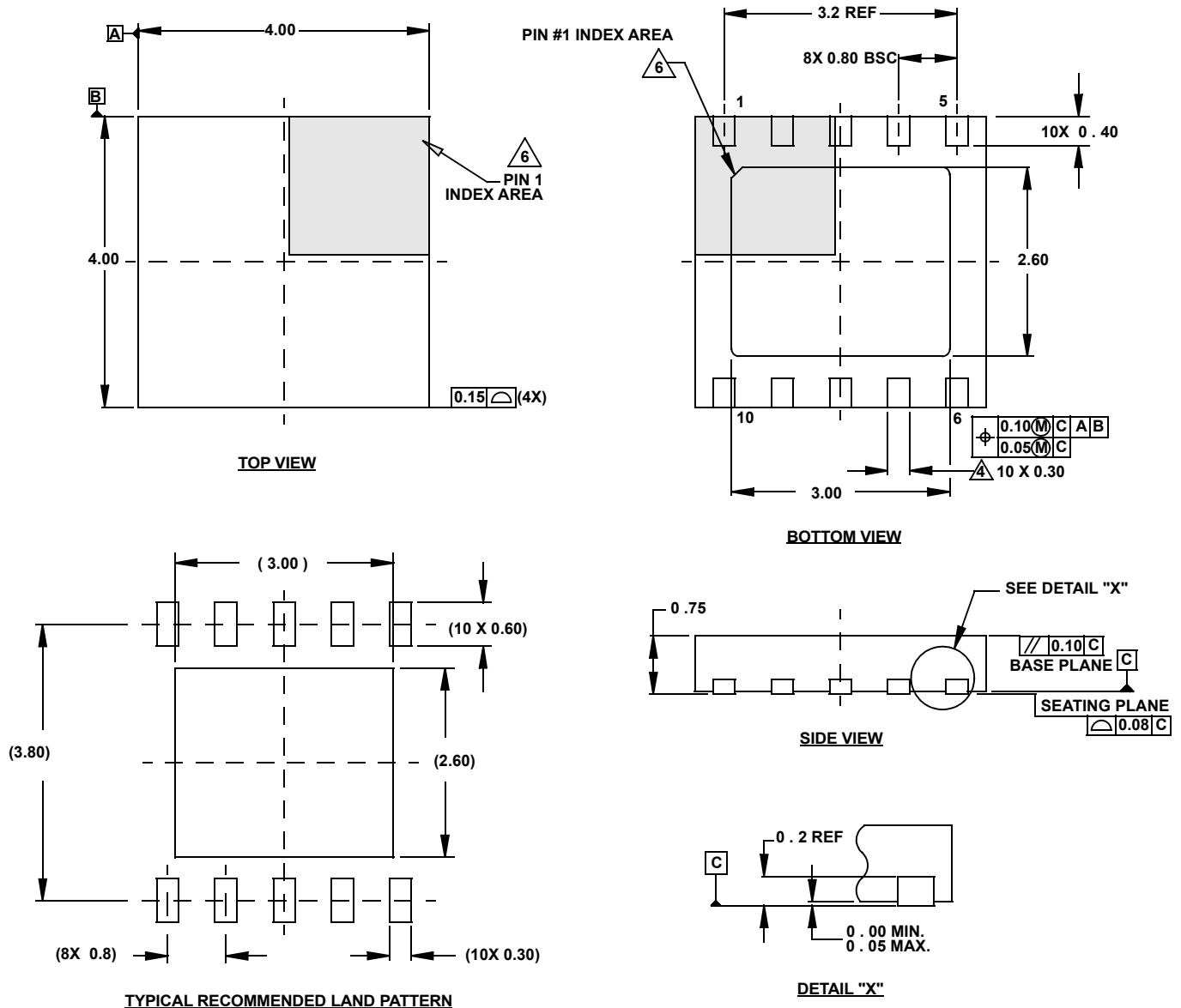
## Package Outline Drawings

For the most recent package outline drawing, see [L10.4x4](#).

L10.4x4

10 LEAD THIN DUAL FLAT NO-LEAD PLASTIC PACKAGE

Rev 2, 4/15



### NOTES:

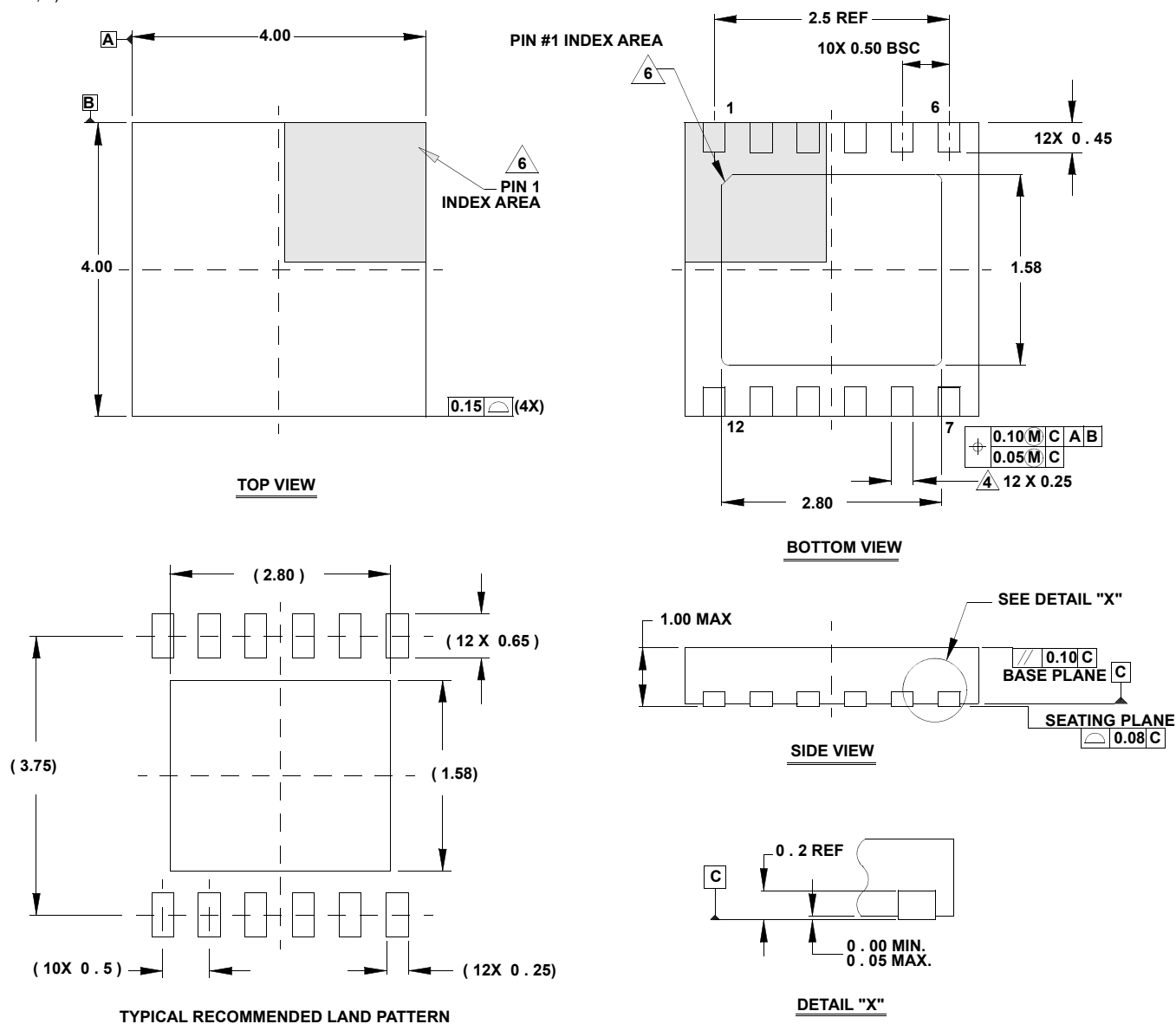
1. Dimensions are in millimeters.  
Dimensions in ( ) for Reference Only.
2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal  $\pm 0.05$
4. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
5. Tiebar shown (if present) is a non-functional feature and may be located on any of the 4 sides (or ends).
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.

For the most recent package outline drawing, see [L12.4x4A](#).

L12.4x4A

12 LEAD DUAL FLAT NO-LEAD PLASTIC PACKAGE

Rev 3, 3/15



#### NOTES:

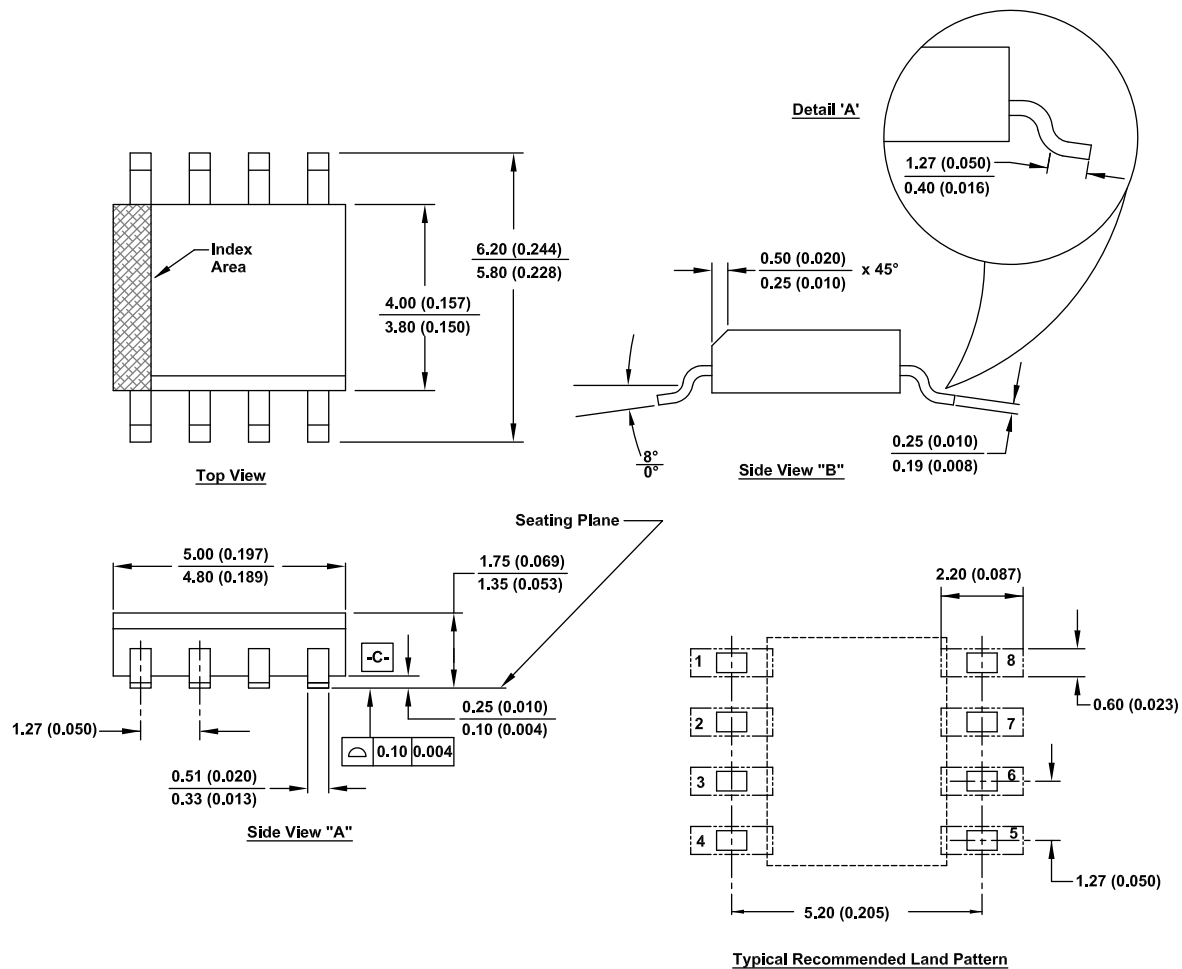
1. Dimensions are in millimeters.  
Dimensions in ( ) for Reference Only.
2. Dimensioning and tolerancing conform to AMSE Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal  $\pm 0.05$
4. Lead width applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
5. Tiebar shown (if present) is a non-functional feature and may be located on any of the 4 sides (or ends).
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.

For the most recent package outline drawing, see [M8.15](#).

## M8.15

## 8 Lead Narrow Body Small Outline Plastic Package

Rev 7, 9/2023



## Notes:

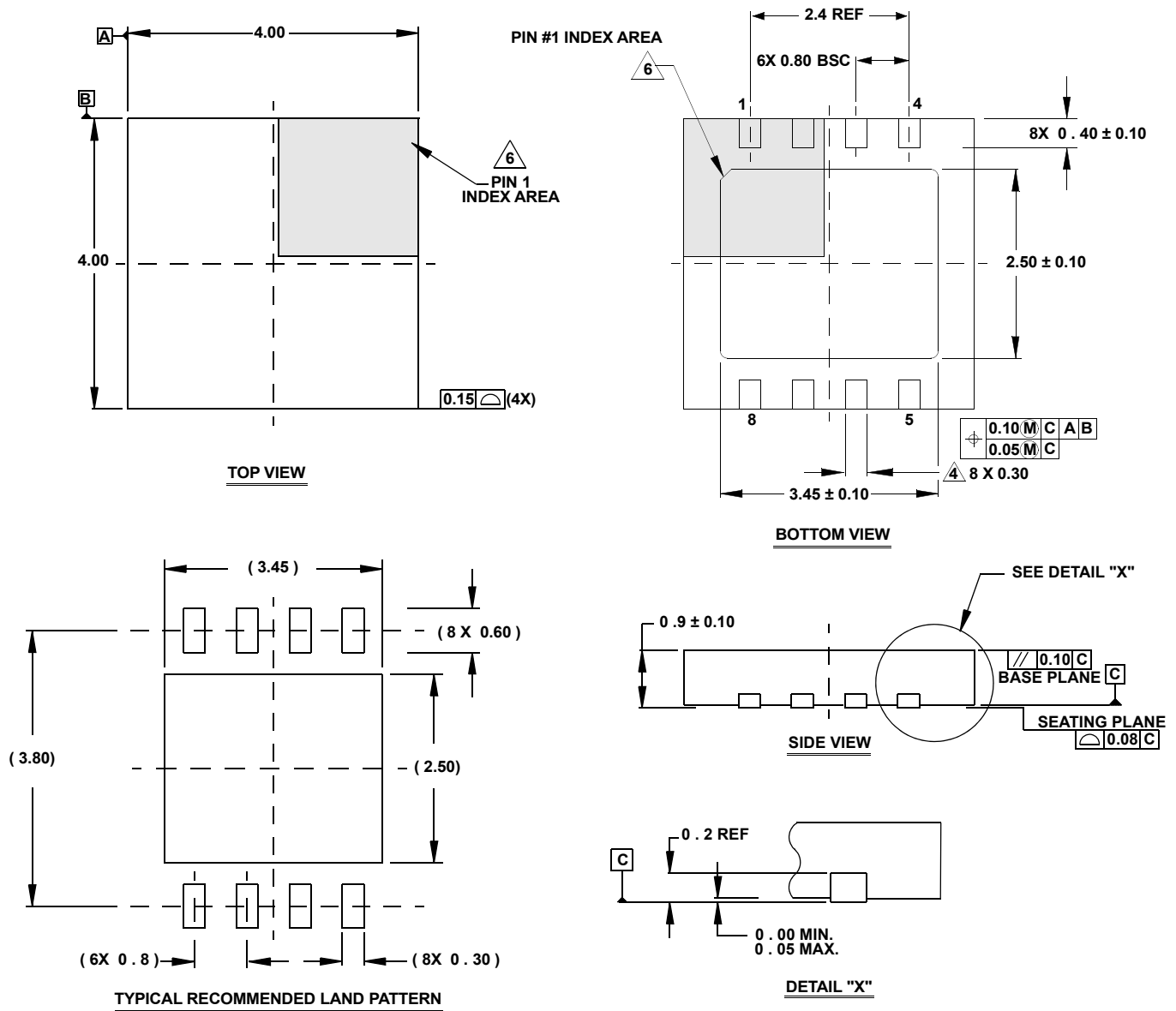
1. Dimension long and tolerancing conform to ASME Y14.5M-1994.
2. Package length does not include mold flash, protrusion or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15mm (0.006 inch) per side.
3. Package width does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25mm (0.010 inch) per side.
4. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
5. Terminal numbers are shown for reference only.
6. The lead width as measured 0.36mm (0.014 inch) or greater above the seating plane, shall not exceed a maximum value of 0.61mm (0.024 inch).
7. Controlling dimension: MILLIMETER. Converted inch dimension are not necessarily exact.
8. This outline conforms to JEDEC publication MS-012-AA ISSUE C.

For the most recent package outline drawing, see [L8.4x4](#).

L8.4x4

8 LEAD DUAL FLAT NO-LEAD PLASTIC PACKAGE

Rev 1, 03/15



**NOTES:**

1. Dimensions are in millimeters.  
Dimensions in ( ) for Reference Only.
2. Dimensioning and tolerancing conform to ASME Y14.5m-1994.
3. Unless otherwise specified, tolerance : Decimal  $\pm 0.05$
4. Dimension applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
5. Tiebar shown (if present) is a non-functional feature and may be located on any of the 4 sides (or ends).
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.

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